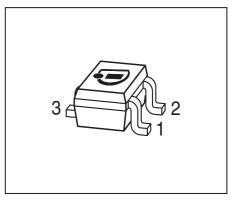


BFR181W

Low Noise Silicon Bipolar RF Transistor

- For low noise, high-gain broadband amplifiers at collector currents from 0.5 mA to 12 mA
- $f_{\rm T}$ = 8 GHz, $NF_{\rm min}$ = 0.9 dB at 900 MHz
- Easy to use Pb-free (RoHS compliant) and halogen free industry standard package with visible leads
- Qualification report according to AEC-Q101 available





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration			Package
BFR181W	RFs	1=B	2=E	3=C	SOT323

Maximum Ratings at T_A = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CEO}	12	V
Collector-emitter voltage	V _{CES}	20	
Collector-base voltage	V _{CBO}	20	
Emitter-base voltage	V _{EBO}	2	
Collector current	I _C	20	mA
Base current	I _B	2	
Total power dissipation ¹⁾	P _{tot}	175	mW
_ <i>T</i> _S ≤ 90 °C			
Junction temperature		150	°C
Ambient temperature	T _A	-65 150	
Storage temperature	T _{Stg}	-65 150	
Thermal Resistance			•

Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R _{thJS}	345	K/W

 ${}^{1}T_{S}$ is measured on the collector lead at the soldering point of the pcb

²For the definition of R_{thJS} please refer to Application Note AN077 (Thermal Resistance Calculation)



Parameter	Symbol	I Values			Unit
		min.	typ.	max.	
DC Characteristics					-
Collector-emitter breakdown voltage	V _{(BR)CEO}	12	-	-	V
$I_{\rm C}$ = 1 mA, $I_{\rm B}$ = 0					
Collector-emitter cutoff current	I _{CES}	-	-	100	μA
$V_{\rm CE}$ = 20 V, $V_{\rm BE}$ = 0					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I _{EBO}	-	-	1	μA
$V_{\rm EB} = 1 \text{V}, I_{\rm C} = 0$					
DC current gain	h _{FE}	70	100	140	-
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, pulse measured					

Electrical Characteristics at T_A = 25 °C, unless otherwise specified



Parameter	Symbol	Values			Unit	
		min.	typ.	max.		
AC Characteristics (verified by random sampling)						
Transition frequency	f _T	6	8	-	GHz	
<i>I</i> _C = 10 mA, <i>V</i> _{CE} = 8 V, <i>f</i> = 500 MHz						
Collector-base capacitance	C _{cb}	-	0.29	0.45	pF	
$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,						
emitter grounded						
Collector emitter capacitance	C _{ce}	-	0.22	-		
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,						
base grounded						
Emitter-base capacitance	C _{eb}	-	0.35	-		
V _{EB} = 0.5 V, <i>f</i> = 1 MHz, V _{CB} = 0 ,						
collector grounded						
Minimum noise figure	NF _{min}				dB	
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
<i>f</i> = 900 MHz		-	0.9	-		
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
<i>f</i> = 1.8 GHz		-	1.2	-		
Power gain, maximum stable ¹⁾	G _{ms}	-	19	-	dB	
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,						
<i>f</i> = 900 MHz						
Power gain, maximum available ²⁾	G _{ma}	-	13.5	-	dB	
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,						
<i>f</i> = 1.8 GHz						
Transducer gain	S _{21e} ²				dB	
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,						
<i>f</i> = 900 MHz		-	15.5	-		
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,						
<i>f</i> = 1.8 MHz		-	10	-		

Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

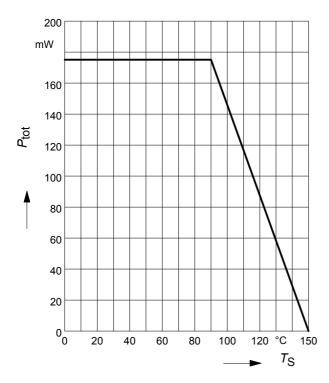
 ${}^{1}G_{\rm ms} = |S_{21} / S_{12}|$ ${}^{2}G_{\rm ma} = |S_{21e} / S_{12e}| \ (k - (k^2 - 1)^{1/2})$



BFR181W

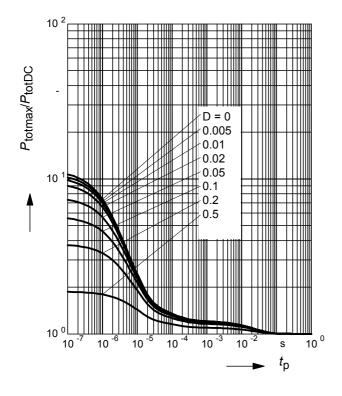
Total power dissipation $P_{tot} = f(T_S)$

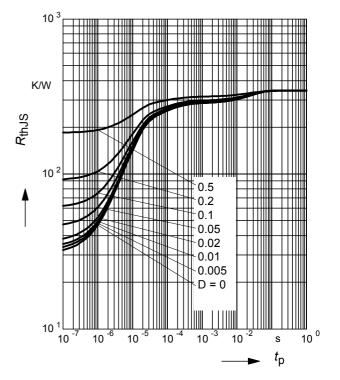
Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$



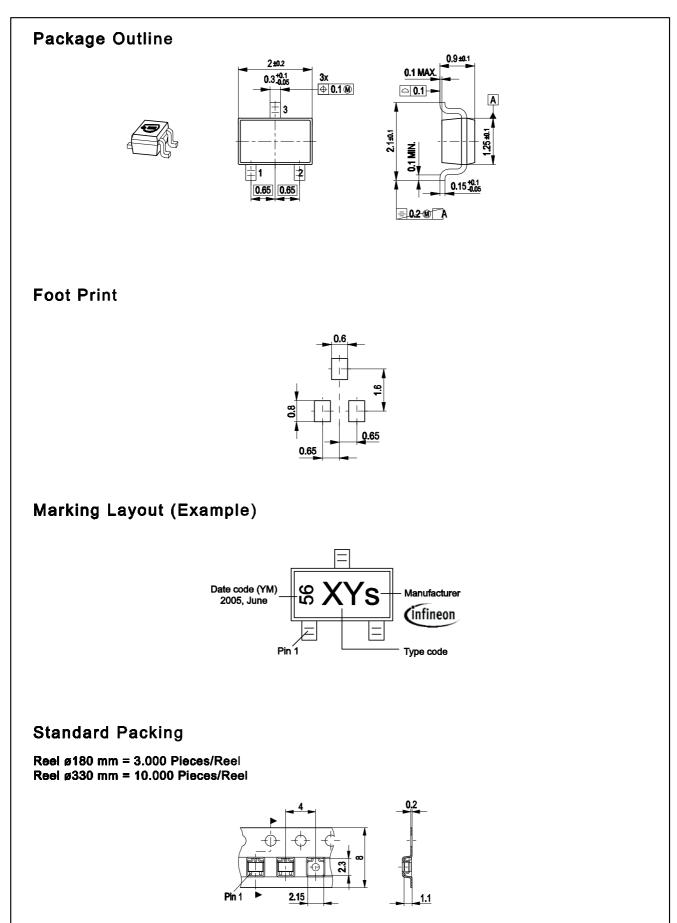
Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$











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